IN THE SPECIFICATION:

04/08/2008 16:36

Please amend paragraph 0013 as follows: [0013]

In order to solve the problem, the invention according to claim 1 of the present invention provides a SAW device comprising a piezoelectric substrate and an IDT that is formed on the piezoelectric substrate and is made from Al or alloy including Al as a main component, an excited wave being an SH wave, characterized in that the piezoelectric substrate is a quartz flat plate where a cut angle 6 of a rotation Y cut quartz substrate is set in a range of 64.09<0< 49.39 in a counterclockwise direction from a crystal Z axis, a rotation Y cut substrate made from a quartz flat substrate, where a cut angle θ of said piezoelectric substrate is a rotation angle of a crystal Z-axis when the piezoelectric substrate is rotated around a crystal X-axis, a direction in which the piezoelectric substrate is rotated from a positive Z-axis side to a positive Y-axis side is a direction in which said cut angle 8 is minus, and the cut angle θ is set in a range of -64.0° < θ < -49.3°, and a propagation direction of a SAW is set to $90^{\circ}\pm5^{\circ}$ ($90^{\circ}\pm5^{\circ}$) to a crystal X-axis, and when a wavelength of the SAW to be excited is represented as λ, an electrode film thickness H/λ standardized by a wavelength of the IDT is set to [[be]] satisfy 0.04< H/λ <0.12.

Please amend paragraph 0016 as follows: [0016]

The invention according to claim 4 provides a SAW device comprising a piezoelectric substrate and an IDT that is formed on the piezoelectric substrate and is made from Al or alloy including Al as a main component, an excited wave being <u>utilized as</u> an SH wave, characterized in that the piezoelectric substrate is a quartz flat plate where a cut angle 8 of a rotation Y cut quartz substrate is set to satisfy a rotation Y cut substrate made from a quartz flat substrate, where a cut angle θ of said piezoelectric substrate is a rotation angle of a crystal Z-axis when the

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piezoelectric substrate is rotated around a crystal X-axis, a direction in which the piezoelectric substrate is rotated from a positive Z-axis side to a positive Y-axis side is a direction in which said cut angle θ is minus, and the cut angle θ is set in a range of $-61.4^{\circ} < \theta < -51.1^{\circ}$ in a counter-clockwise-direction from a crystal Z-axis, and a propagation direction of a SAW is set to $90^{\circ} \pm 5^{\circ}$ ($90^{\circ} \pm 5^{\circ}$) to a crystal X-axis, and when a wavelength of the SAW to be excited is represented as λ , an electrode film thickness H/ λ standardized by a wavelength of the IDT is set to satisfy $0.05 < H/\lambda < 0.10$.